

28/April/2011

DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
0	Oct-27-2009	First Issue	MH
1	Dec-11-2009	Update Backlight Characteristics	MH
2	April-28-2011	Update Electrical characteristics at P5	AFA

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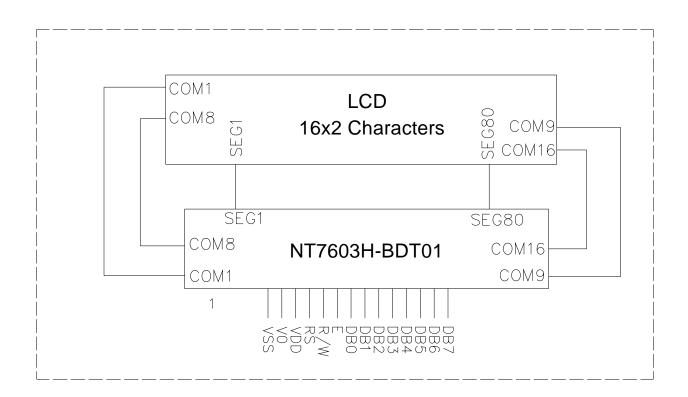
<u>1. FUNCTIONS & FEATURES</u>

Display Format LCD Mode Viewing Direction Driving Scheme Power Supply Voltage (V_{DD}) LCD Driving Voltage (V_{LCD}) Operation Temperature Storage Temperature Backlight : 16x2 Characters, COG
: FSTN / Positive / Transflective
: 6 o'clock
: 1/16 Duty cycle, 1/5 Bias
: 5.0 Volt (typ.)
: 4.5 Volt (Typ. Reference Voltage)
: -20°C to +70°C
: -30°C to +80°C
: LED, White, Lightguide

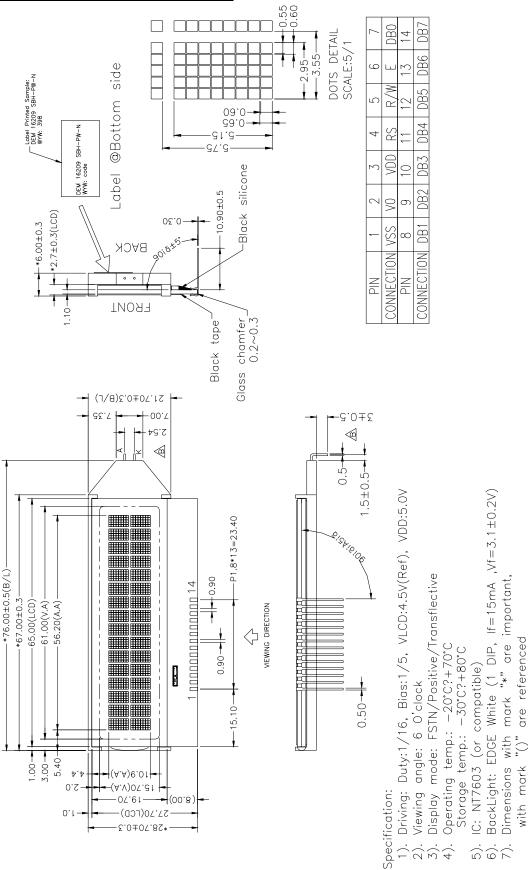
2. MECHANICAL SPECIFICATIONS

Module Size	: 76.00 x 28.70 x 6.00 mm
Viewing Area	: 61.00 x 15.70 mm
Character Pitch	: 3.55 x 5.75 mm
Character Size	: 2.95 x 5.15 mm
Dot Pitch	: 0.60 x 0.65 mm
Dot Size	: 0.55 x 0.60 mm

3. BLOCK DIAGRAM



4. DIMENSIONAL OUTLINE



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All the raw materials are RoHS compliant

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5. PIN DESCRIPTION

No.	Symbol	Function
1	VSS	Power supply(-)
2	V0	Power supply for LCD driver
3	VDD	Power supply(+5.0V)
4	RS	Register select signal 0: Instruction register (write), Busy flag, address counter (read) 1: Data register (write, read)
5	R/W	Read/Write control signal 0: Write 1: Read
6	Е	Read/Write start signal
7~14	DB0~DB7	Date Bus Lines

6. MAXIMUM ABSOUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	Vdd	-0.3	7.0	V
Supply Voltage for LCD	V0	GND	V _{DD} +0.3	V
Input Voltage	Vin	-0.3	V _{DD} +0.3	V
Supply Current for Backlight	$I_F(Ta = 25^{\circ}C)$		15+15*20%	mA
Reverse Voltage for Backlight	$V_R(Ta = 25^{\circ}C)$		5	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Tst	-30	80	°C

7. ELECTRICAL CHARACTERISTICS

DC Electrical Characteristics (continued)

V_{DD} =5.0V,GND=0V,T_A=25°C) Symbol Parameter Min. Max. Unit Conditions Applicable Pin Typ. ٧ VDD Operating Voltage 5.0 5.5 2.8 DB0 - DB7, RS, ViH1 "H" Level Input Voltage (1) 0.8 VDD VDD ٧ 4 R/W, "L" Level Input Voltage (1) ٧ VIL1 -0.3 0.2 VDD E,OSC1 -V IOH = -1.2m A VOH1 "H" Level Output Voltage (1) VDD - 0.6 DB0 - DB7 -VOL1 "L" Level Output Voltage (1) 1 GND + 0.6 ٧ IOL = 1.2mA (CMOS) -VCOM Driver Voltage Descending (COM) ٧ COM1 - 16 0.3 $ID = 5\mu A$ --٧ VSEG Driver Voltage Descending (SEG) 0.3 $ID = 5\mu A$ SEG1 - 80 --Not include VIN = 0 to VDD Input Leakage Current μA **IIL** -1 1 OSC1 RS, R/W, 125 -IP Pull-up MOS Current 50 250 μA VDD = :5V DB0-DB7 Rf oscillation. from external clock VDD = 5.0 V, fosc = fcp = 1.5 IOP Power Supply Current 1 mA VDD 540KHz, include LCD bias current. External Clock Operation External Clock Operating fCP 380 540 750 KHz Frequency **tDUTY** External Clock Duty Cycle 45 50 55 % tRCP External Clock Rising Time 0.1 -0.5 μS tFCP External Clock Falling Time 0.1 0.5 μS Internal Clock Operation (Built-in RC Oscillator) Rf = $50K\Omega$ (reference only) fOSC 380 540 Oscillator Frequency 750 KHZ VDD = 2 .8V ~ 5.5V VLCD LCD Driving Voltage VDD V VDD - V5 _ 3.0

8. TIMING CHARACTERISTICS

Read Operation

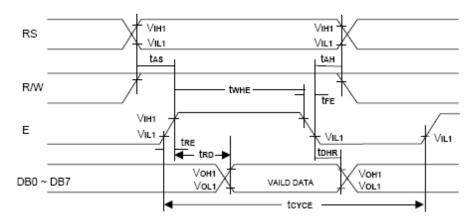


Figure 1. Bus Read Operation Sequence (Reading out data from NT7603 to 8-bit MPU)

Write Operation

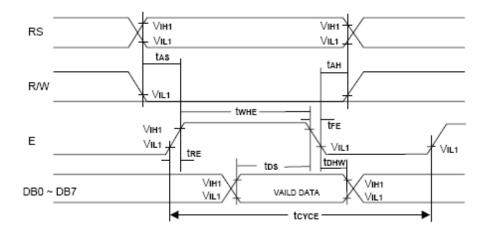


Figure 2. Bus Write Operation Sequence (Writing data from 8-bit MPU to NT7603)

Interface Signals with Segment Driver LSI

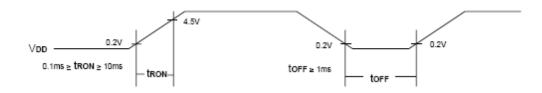


Figure 3. toFF stipulates the time of power OFF for instantaneous Power supply to or when power supply repeats ON and OFF

9. CONTROL AND DISPLAY INSTRUCTION

Instruction					C	ode	Function	Execution time (max)					
matuction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(fOSC = 540KHz)	
Display Clear	0	0	0	0	0	0	0	0	0	1	Clear entire display area, Restore display from shift, and load address counter with DD RAM address 00H.	1.64ms	
Display/ Cursor Home	0	0	0	0	0	0	0	0	1	*	Restore display from shift and load address counter with DD RAM address 00H.	1.64ms	
Entry Mode Set	o	0	0	0	0	0	0	1	I/D	s	Specify direction of cursor movement and display shift mode. This operation takes place after each data transfer (read/write).	40µs	
Display ON/OFF	O	0	0	0	0	0	1	D	с	в	Specify activation of display (D) cursor (C) and blinking of character at cursor position (B).	40µs	
Display/ Cursor Shift	o	O	0	0	0	1	S/C	R/L	*	*	Shift display or move cursor.	40µs	
Function Set	0	0	0	0	1	DL	Ν	F	*	×	Set interface data length (DL), number of display line (N), and character font (F).	40µs	
RAM Address Set	0	0	0	1 ACG						Load the address counter with a CG RAM address. Subsequent data access is for CG RAM data.	40µs		
DD RAM Address Set	o	0	1				ADD				Load the address counter with a DD RAM address. Subsequent data access is for DD RAM data.	40µs	
Busy Flag/ Address Counter Read	0	1	BF				AC		Read Busy Flag (BF) and contents of Address Counter (AC).	1µs			
CG RAM/ DD RAM Data Write	1	0				Write	e data			Write data to CG RAM or DD RAM.	40µs		
CG RAM/ DD RAM Data Read	1	1				Read	l data			Read data from CG RAM or DD RAM.	40µs		
	S = D = C = B = S/C = R/L = DL = N = F = BF =										DD RAM : Display Data RAM CG RAM : Character Generator RAM ACG : Character Generator RAM Address ADD : Display Data RAM Address AC : Address Counter		

Note 1: Symbol "*" signifies an insignificant bit (disregard).

Note 2: Correct input value for "N" is predetermined for each model.

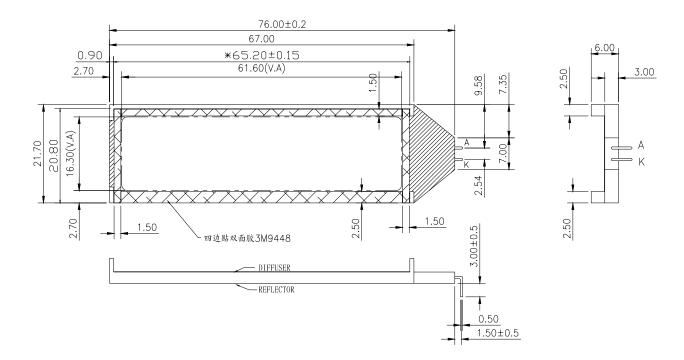
Note 3: The variation of execution time depends on the change of oscillator frequency; for example:

if fOSC = 380KHz, then execution time = 40µs× (540KHz / 380KHz) = 57µs

10. Font Characteristic

					High	er 4-bit	(D4 to I	D7) of (Characte	er Code	(Hexac	lecimal))				
┝	_	0	1	2	3	4	5	6	7	8	9	A	В	с	D	E	F
	0	CG RAM (1)			U	Ð			P					9	Ξ,	Ċ	p
	1	CG RAM (2)		1	1	Α	Q	9	-			m	7	÷	ć,	ġ	q
	2	CG RAM (3)		11	2	B	R	b	ŀ			ľ	4	Ņ	×	P	Θ
	3	CG RAM (4)		₩	3	C	-	<u>.</u>	≝.				ņ	7	E	<u>.</u>	÷
	4	CG RAM (5)		\$	4	D	Τ	C	t.			•		ŀ	þ	.4	Ω
	5	CG RAM (6)			5	E.,	U		L.,				7	. 		c	ü
	6	CG RAM (7)		8	6			÷	Ų			Ņ	ŢŢ			p	2
lexadecimal)	7	CG RAM (8)		3	7	6	IJ	9	IJ			7	Ŧ		7	9	π
acter Code ()	8	CG RAM (1)		Ċ	8	$\left \cdot \right $	X	ŀ'n	×			d,	7	4	Ņ	.,"	X
to D3) of Chai	9	CG RAM (2)			9		Ŷ	i	<u>ب</u>			÷	Ţ		IĿ	1	9
Lower 4-bit (D0 to D3) of Character Code (Hexadecimal)	٨	CG RAM (3)		: :	:	.J	2	.]]	Ü	L/		Ŧ
Low	в	CG RAM (4)				K	Ľ	K	÷			7	ţ	Ŀ		×	F
	с	CG RAM (5)		:=		L	¥	1				†?	:		ņ	¢	PI
	D	CG RAM (6)				M]	M	}				7	÷.		ŧ	÷
	E	CG RAM (7)			2	ŀ	·^.	ľ	÷				Ľ	1	•••	ň	
	F	CG RAM (8)			?	0		O	÷			.i.i	۱. ا			Ö	

11. BACKLIGHT CHARACTERISTICS



LCD Module with Edge LED Backlight

ELECTRICAL RATINGS

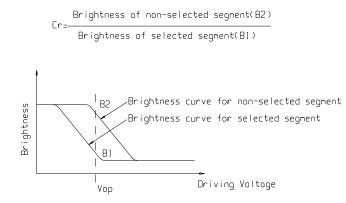
					Ta = 25	5°C
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=15mA	2.9	3.1	3.3	V
Reverse Current	Ir	VR=5.0V		10		uA
Luminous Intensity (Without LCD)	Lv	IF=15mA	140	190		Cd/m ²
Wave length	λρ	IF=15mA	X=0.26 Y=0.26		X=0.30 Y=0.30	
Color	White					

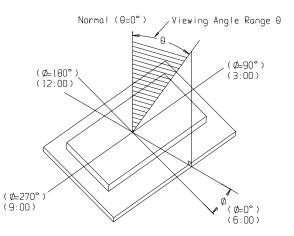
Note:

when the temperature exceed 25°C, the approved current decrease rate for Backlight change as the temperature increase is: -0.36mA/°C (below 25°C, the current refer to constant, which would not change with temperature).

12. ELECTRO-OPTICAL CHARACTERISTICS

				(VD	$_{\rm D}$ =5.0V, '	$Ta = 25^{\circ}C$)	
Item	Symbol	Condition	Min	Тур	Max	Unit	
Operating Voltage of		Ta =-20°C	4.7	5.0	5.3		
Operating Voltage of LCD	Vlcd	$Ta = 25^{\circ}C$	4.2	4.5	4.8	V	
LCD		$Ta = 70^{\circ}C$	3.7	4.0	4.3		
Pagnonga tima	Tr	$Ta = 25^{\circ}C$		100	160	ms	
Response time	Tf	1a - 23 C		150	200	ms	
Contrast	Cr	$Ta = 25^{\circ}C$		4			
	θ	$C_{n} \geq 2$	-20		+20	deg	
Viewing angle range	Φ	Cr≥2	-30		+30	deg	





13. PRECAUTION FOR USING LCD/LCM

After reliability test, recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours (average) under ordinary operating and storage conditions room temperature (20±8°C), normal humidity (below 65% RH), and in the area not exposed to direct sun light. Using LCM beyond these conditions will shorten the life time.

Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting DISPLAY.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: $350^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

DISPLAY LCDs and modules are not consumer products, but may be incorporated by DISPLAY's customers into consumer products or components thereof, DISPLAY does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of DISPLAY is limited to repair or replacement on the terms set forth below. DISPLAY will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between DISPLAY and the customer, DISPLAY will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with DISPLAY general LCD inspection standard . (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.